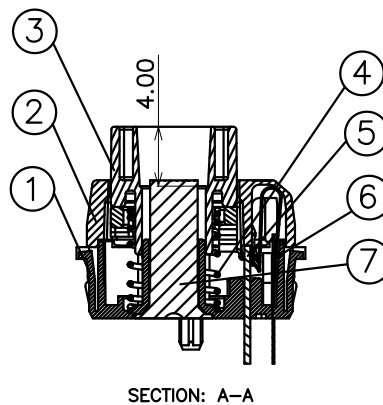
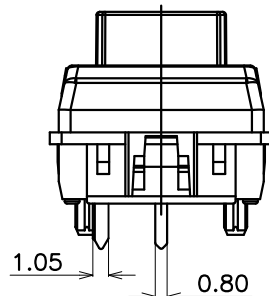
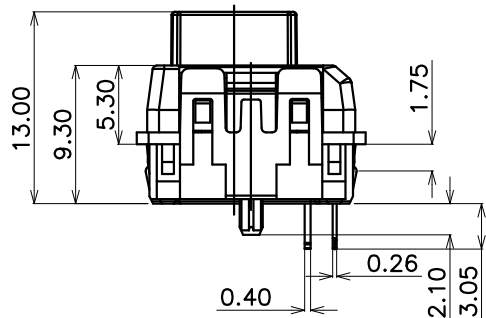
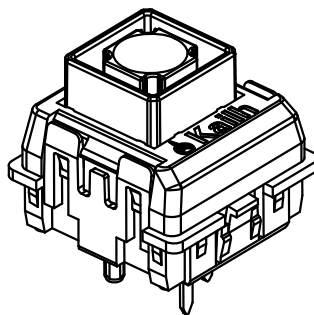
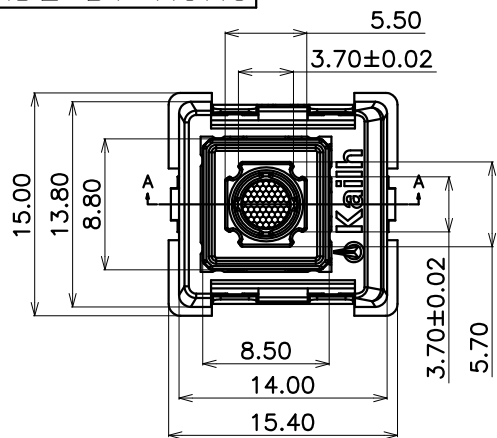
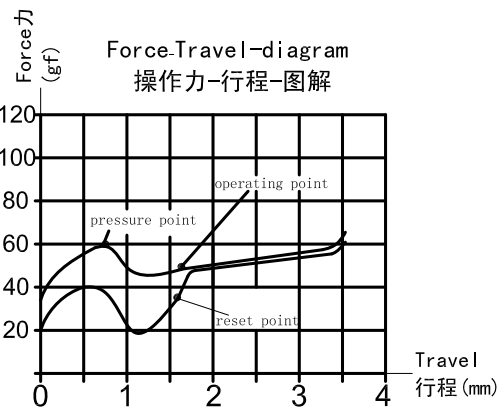
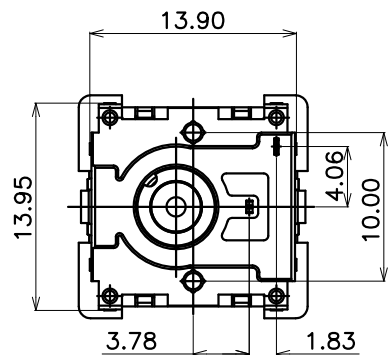


ABIDE BY ROHS



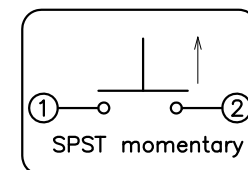
Soft Tactile feel



Specification :

1. Rating:
Voltage : 12V AC/DC max., 2V DC min.
Current: 10mA AC/DC max., 10 μ A DC min.
2. Contact Resistance : 200m Ω Max
3. Insulation Resistance : 100M Ω at DC500V
4. Withstand Voltage : AC100V (50-60Hz) for 1 minute
5. Bounce Time: $\leq$ 5msec (at 16 in/sec. actuation speed)
6. Operation Force : 50 $\pm$ 10gf (40-85gf for total travel)
7. Pretravel: 1.6 $\pm$ 0.5mm
8. Total travel: 3.6 $\pm$ 0.5mm
9. Operating Life : 50,000,000 Cycles

SWITCH FUNCTION

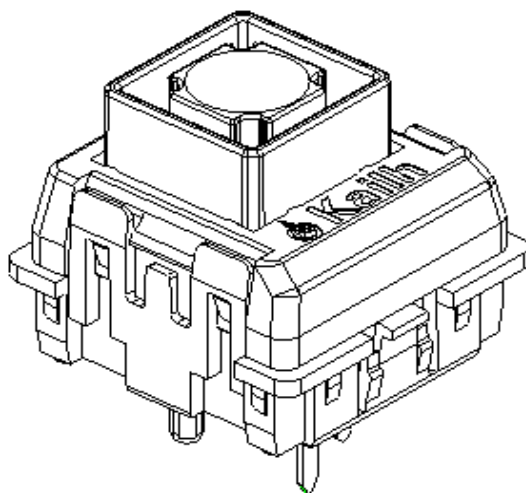


⑦	Light pipe	—	1	PC	—	—
⑥	Terminal B	—	1	Copper Alloy	—	—
⑤	Terminal A	—	1	Copper Alloy	Nature	—
④	Spring	—	1	Stainless Steel	—	—
③	Keystroke	—	1	POM	Brown	—
②	Cover	—	1	PA	Black	—
①	Base	—	1	PA	Black	—
ITEM	PART NAME	TER'NO.	QTY.	MATERIAL	FINISHING	REMARK

APPROVALS		DATE		 DONGGUAN CITY KAIHUA ELECTRONICS CO.,LTD			
DRAWN	Luohengjun	2017.1.5		Kailh			
CHECKED				TITLE:	PG1593 KeySwitches with LED		
APPROVALS				PART NO.	CPG159301S08		
TOLERANCES ARE		30<L	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 
		10<L	±0.20				
		5<L	±0.15				
		L≤5	±0.10				
		±2'		DRAWING NO.	KHA-PG1593-008EN	SHEET 1 OF	

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	B		变更静音片材质，取消静音电镀工艺。	Wu Chuandong		
	A		NEW			

Product Specification



P/N: _____

CPG159301S08

Title :

PG1593 keyboard Switch

Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
A	— —	New releasing	WANGYONGXIAN 2017-05-31	HUYUANGFENG 2017-05-31	David 2017-05-31

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1. Scope:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

2. Product Application:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

3. Technology Parameters:

Ambient Humidity:	45~85% R.H.;
Operating Temperature Range:	-10℃~+70℃;
Storage Temperature Range:	-20℃~+70℃;
Suggested storage period :	about 6 months
Require the tin part on the switch terminals should keep good after storage guarantee date	

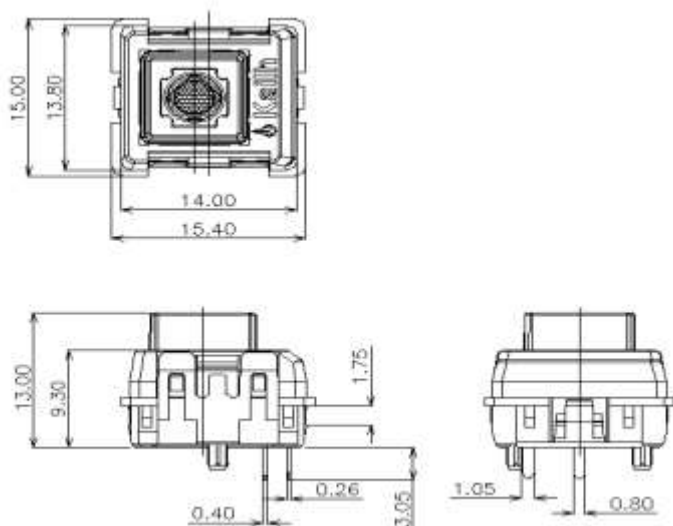
Normal Condition:

Ambient temperature:	20±2℃
Relative humidity:	65%±5% R.H.;
Air pressure :	86~101KPa;
Solder Ability :	Tim-lead soldering : 245℃±5℃ 5s±0.5s;
	Lead-free welding : 255℃±5℃ 5s±0.5s;
Withstand Soldering Temperature:	Wave soldering: 260±5℃ 5±0.5s;

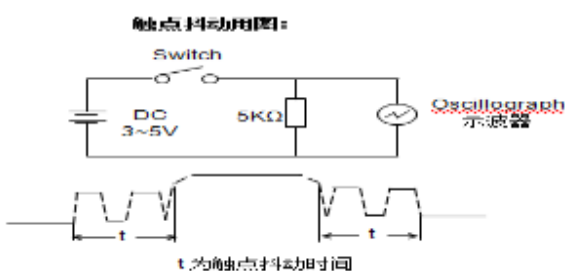
4. Ratings:

Rating:	12V AC/DC max. 2V DC min.
	10mA AC/DC max. 10 μ A DC min;
Insulation Resistance:	≥100MΩ/DC 100V;
Withstand Voltage:	100V AC 1 Minute;
Mechanical Life:	50,000,000 Cycles.

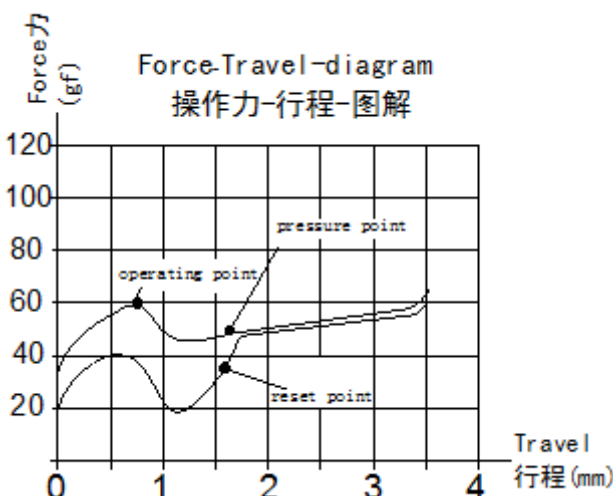
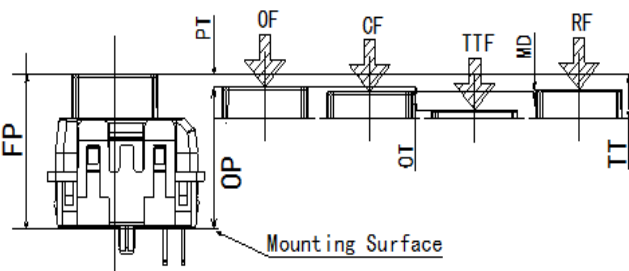
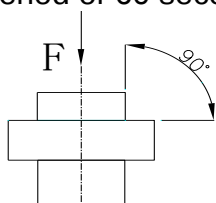
5. Profile Dimensions :

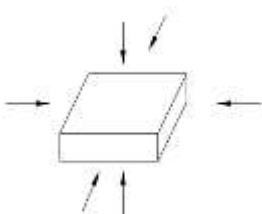


6. Electrical Performance:

Item	Description	Test Condition	Requirement
6.1	Contact Resistance	Static load: (Operation force)x2, which is applied on the center of Switch stem. Be measured when the switch contact stabilization. Measurement tool: Contact resistance Meter. (1KHz, 20mV, 5~50mA) Measured at low current (100mA or less).	200mΩ Max
6.2	Insulation Resistance	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	100MΩ Min
6.3	Dielectric withstanding voltage	Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	No evidence of breakdown.
6.4	Bouncing	Operation speed: 3~4 times/s Oscilloscope Switch Bouncing Test Circuit.  触点抖动电路: Switch DC 3~5V 5KΩ Oscilloscope 示波器 t 为触点抖动时间	Before Life cycle: On: 5ms MAX Off: 5ms MAX After Life cycle: On: 10ms MAX Off: 10ms MAX

7. Mechanical Performance:

Item	Description	Test Condition	Requirement
7.1	Load Curve	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.  Force-Travel-diagram 操作力-行程-图解	See page 9
7.2	Loading parameter	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. 	See page 9
7.3	Static Strength	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds. 	No damage (Electrical) And mechanical)

7.4	Stem Pull Strength	Break by a pull force applied opposite to the direction of stem operation.	5kgf Min
7.5	Shock	Measured by according to the below condition: (1) Acceleration: 80g accelerated speed (2) Cycles of test: 3 cycles each in 6 directions, for a total of 18 cycles. 	Shall meet No.6, 7.1, 7.2.
7.6	Life Test	1) D.C.12V 10mA resistance load 2) Operation speed : 5-6 times / s 3) Push force : Maximum value of operation force.f 4) Operation number: 50,000,000cycles	Contact resistance: 1 Ω Max Bouncing: 10ms Max Operation force and tactile force: Variation rate within ±30%

8. Environmental Performance:

Item	Description	Test Condition	Requirement
8.1	Cold test	(1) Temperature : - 20±2℃ (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test : 1	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2

8.2

Heat test

- (1) Temperature : $70 \pm 2^{\circ}\text{C}$
- (2) Duration of test: 48h
- (3) Take off a drop water
- (4) Standard conditions after test : 1h

Contact resistance:
200m Ω Max
Shall meet :
No. 6.2 to 6.4
No. 7.1 to 7.2

8.3

Temperature cycle

- (1) Test cycles: 5 cycles
- (2) Standard condition after test: 1h

	Temperature	Duration of test
1 cycle	$20 \pm 5^{\circ}\text{C}$	1h
	$-20 \pm 5^{\circ}\text{C}$	1h
	$20 \pm 5^{\circ}\text{C}$	h
	$70 \pm 5^{\circ}\text{C}$	1h

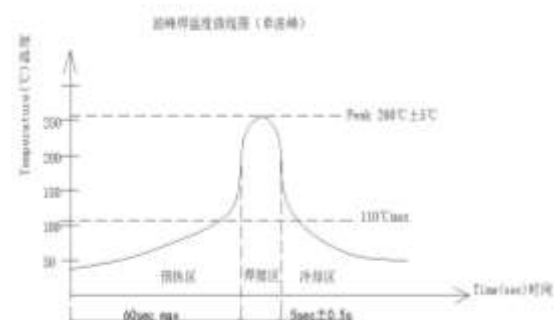
Contact resistance:
200m Ω Max
Shall meet :
No. 6.2 to 6.4
No. 7.1 to 7.2

8.4

Soldering heat test

Soldering area: 1/2 of PWB thickness.
(PWB: T=1.6mm)

Soldering temperature: $260 \pm 5^{\circ}\text{C}$
Soldering time: $5 \pm 0.5\text{s}$



Appearance:
No abnormality.

8.5

Solder ability

Lead-tin soldering:
Soldering temperature: $245 \pm 5^{\circ}\text{C}$
Soldering time: $5 \pm 0.5\text{s}$

Lead free soldering:
Soldering temperature: $255 \pm 5^{\circ}\text{C}$
Soldering time: $5 \pm 0.5\text{s}$

At least 90% of surface area of immersed portion shall be covered by solder.

Product Specification

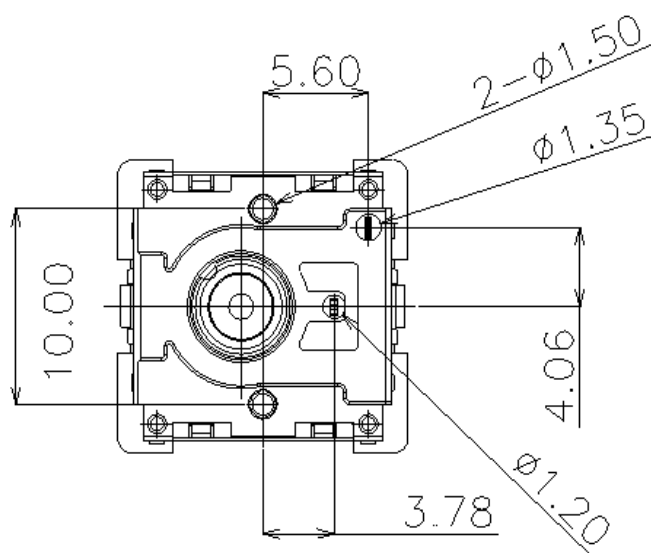
P/N: CPG159301S08	DOC. No.: KH-PS1701-09	Rev.: A	Page: 8/10
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8.6	Humidity test	(1) Temperature : $60 \pm 2^{\circ}\text{C}$ (2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water (5) Standard conditions after test: 1h	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2
8.7	Salt Spray	Apply the following environment to test(Only for contact test) : (1) Temperature : $35 \pm 5^{\circ}\text{C}$ (2) Salt water density: $5 \pm 1\%$ (3) Duration: 12hours (4) After test, the salt deposit shall be removed by running water.	Appearance: No corrosion spot, no crack, no base plate naked. Contact Resistance: 200 m Ω Max
	Withstand K ₂ S	Apply the following environment to test: (1) Temperature: $35 \pm 5^{\circ}\text{C}$ (2) K ₂ S Density: 2%; (3) Duration: 2 minute.	Appearance: No corrosion spot, no crack, no base plate naked. . Contact Resistance: 1000 m Ω Max

9. Recommended PCB Layout

(Top View)

(Single face board T=1.6mm)

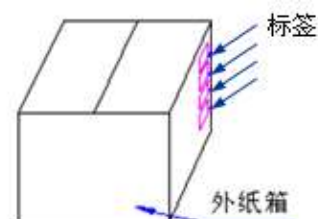
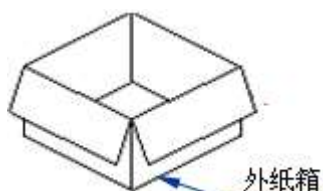


10. Loading Parameter (TT/PT/OT /OF/TF/RF) Specification :

Parameter	Unit	Specification	Remark
FP	mm	13±0.5	
OP	mm	11.4±1.0	
PT	mm	1.6±0.5	
OF	gf	60±10	
CF	gf	50±10	
RF	gf	13	Min
TT	mm	3.6±0.5	

11. Packaging :

Packaging type:Tray, 1000Pcs/Tray, 4000Pcs/Carton.



12. Precaution

12.1 Immersion Soldering condition

ITEM	CONDITION
Preheat temperature	110°C Max (Ambient temperature of soldering surface of P.W.B)
Preheat time	60s, Max
Area of flux	1/2 Max of PWB Thickness
Temperature of solder	260±5°C 260±5°C
Time of immersion	5±0.5s 5±0.5s
Number of soldering	2time Max (But should down heat of the first soldering)
Printed wiring board	Single side copper-clad laminates

- (1) After switches were soldered, please be careful not to clean switches with solvent
- (2) Under the condition of using soldering iron, soldering temperature shall be 350°C±5°C with 3±0.5s.

12.2 Notes

- (1) Please be cautious not to give excessive static load or shock to switches.
- (2) Please be careful not to stack up P. W. B. after switches were soldered.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided
Especially. When you need to preserve for a long period, do not open the carton.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
- (5) This Product Specification is considered as the technical agreement on product between the receiving customer and Kailh. Any information on Product Catalogue which is in conflict with or different from the corresponding information of this document is considered as invalid.
- (6) It will be considered that customer already confirmed and accepted this specification if customer issue purchase order to us directly.
- (7) If there is no order or no request for new specification after 1 year upon this specification is issued, the specification will be regarded as invalid.
- (8) Products meet the ROHS & REACH environmental management substances control standards